**1-bit dual supply translating transceiver; 3-state** Rev. 2 — 3 February 2022 Proc

**Product data sheet** 

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## 1. General description

The 74AXP1T45 is a single bit, dual supply transceiver with 3-state output that enables bidirectional level translation. It features two 1-bit input-output ports (A and B), a direction control input (DIR) and dual supply pins ( $V_{CC(A)}$  and  $V_{CC(B)}$ ). Both  $V_{CC(A)}$  and  $V_{CC(B)}$  can be supplied at any voltage between 0.9 V and 5.5 V making the device suitable for translating between any of the low voltage nodes (0.9 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). No power supply sequencing is required and output glitches during power supply transitions are prevented using patented circuitry. As a result glitches will not appear on the outputs for supply transitions during power-up/down between 20 mV/µs and 5.5 V/s. Pins A and DIR are referenced to  $V_{CC(A)}$  and pin B is referenced to  $V_{CC(B)}$ . A HIGH on DIR allows transmission from A to B and a LOW on DIR allows transmission from B to A.

The device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either  $V_{CC(A)}$  or  $V_{CC(B)}$  are at GND level, both A and B are in the high-impedance OFF-state.

# 2. Features and benefits

- Wide supply voltage range:
  - V<sub>CC(A)</sub>: 0.9 V to 5.5 V
  - V<sub>CC(B)</sub>: 0.9 V to 5.5 V
- Low input capacitance; C<sub>I</sub> = 1.5 pF (typical)
- Low output capacitance; C<sub>O</sub> = 3.8 pF (typical)
- Low dynamic power consumption; C<sub>PD</sub> = 11 pF (typical)
- Low static power consumption; I<sub>CC</sub> = 2 µA (25 °C maximum)
- High noise immunity
- Complies with JEDEC standard:
  - JESD8-12 (1.1 V to 1.3 V; inputs)
  - JESD8-11 (1.4 V to 1.6 V)
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
  - JESD12-6 (4.5 V to 5.5 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD78D Class II
- Inputs accept voltages up to 5.5 V
- Low noise overshoot and undershoot < 10% of V<sub>CCO</sub>
- IOFF circuitry provides partial power-down mode operation
- Specified from -40 °C to +125 °C

# 3. Ordering information

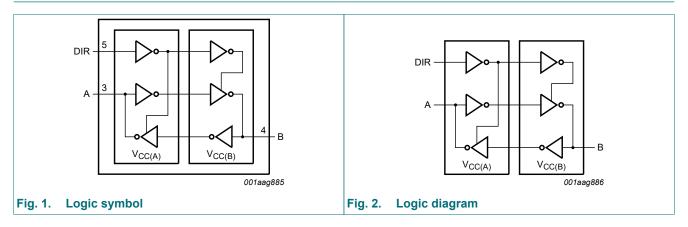
Type number	Package									
	Temperature range	Name	Description	Version						
74AXP1T45GW	-40 °C to +125 °C	TSSOP6	plastic thin shrink small outline package; 6 leads; body width 1.25 mm	SOT363-2						
74AXP1T45GX	-40 °C to +125 °C	X2SON6	plastic thermal enhanced extremely thin small outline package; no leads; 6 terminals; body 1.0 × 0.8 × 0.32 mm	SOT1255-2						

# 4. Marking

Table 2. Marking	
Type number	Marking code [1]
74AXP1T45GW	R5
74AXP1T45GX	R5

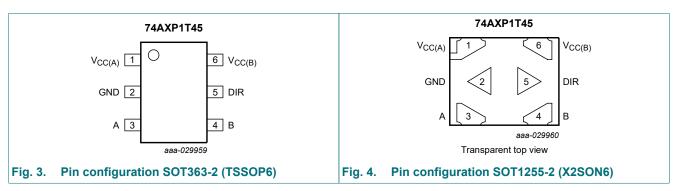
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram



# 6. Pinning information

## 6.1. Pinning



### 6.2. Pin description

Table 3. Pin desc	ription	
Symbol	Pin	Description
V <sub>CC(A)</sub>	1	supply voltage A (A and DIR are referenced to $V_{CC(A)}$ )
GND	2	ground (0 V)
A	3	data input or output
В	4	data input or output
DIR	5	direction control
V <sub>CC(B)</sub>	6	supply voltage B (B is referenced to V <sub>CC(B)</sub> )

# 7. Functional description

### Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Supply voltage	Input	Input/output [1]					
$V_{CC(A)}, V_{CC(B)}$	DIR [2]	A [2]	B [2]				
0.9 V to 5.5 V	L	A = B	input				
0.9 V to 5.5 V	Н	input	B = A				
GND [1]	Х	Z	Z				

 $\label{eq:linear} [1] \quad \mbox{If at least one of $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.}$ 

[2] A and DIR are referenced to  $V_{CC(A)}$ ; B is referenced to  $V_{CC(B)}$ .

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			•		10	,
Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A			-0.5	+6.5	V
V <sub>CC(B)</sub>	supply voltage B			-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-20	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I <sub>OK</sub>	output clamping current	V <sub>0</sub> < 0 V		-20	-	mA
Vo	output voltage	Active mode	[1][2][3]	-0.5	V <sub>CCO</sub> + 0.5	V
		Suspend or 3-state mode	[1]	-0.5	+6.5	V
lo	output current	$V_{O}$ = 0 V to $V_{CCO}$	[2]	-	±25	mA
I <sub>CC</sub>	supply current	$I_{CC(A)}$ or $I_{CC(B)}$ ; per $V_{CC}$ pin		-	100	mA
I <sub>GND</sub>	ground current	per GND pin		-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[4]	-	250	mW
	-					1

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V<sub>CCO</sub> is the supply voltage associated with the output port.

[3]  $V_{CCO}$  + 0.5 V should not exceed 6.5 V.

[4] For SOT363-2 (TSSOP6) package: P<sub>tot</sub> derates linearly with 3.7 mW/K above 83 °C.

For SOT1255-2 (X2SON6) package: Ptot derates linearly with 3.3 mW/K above 75 °C.

# 9. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A		0.9	5.5	V
V <sub>CC(B)</sub>	supply voltage B		0.9	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode [1]	0	V <sub>cco</sub>	V
		Suspend or 3-state mode	0	5.5	V V V V V °C ns/V ns/V ns/V ns/V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CCI</sub> = 0.9 V [2]	-	20	°C ns/V ns/V
		V <sub>CCI</sub> = 1.2 V	-	20	ns/V
		V <sub>CCI</sub> = 1.4 V to 1.95 V	-	20	ns/V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	-	20	ns/V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	-	10	ns/V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	-	8	ns/V

#### Table 6 Recon mended operating conditions

# **10. Static characteristics**

### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		+25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
V <sub>IH</sub>	HIGH-level	A, B and DIR input [	1]							
	input voltage	V <sub>CCI</sub> = 0.9 V	0.7 × V <sub>CCI</sub>	-	-	$0.7 \times V_{CCI}$	-	$0.7 \times V_{CCI}$	-	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	0.65 × V <sub>CCI</sub>	-	-	0.65 × V <sub>CCI</sub>	-	0.65 × V <sub>CCI</sub>	-	V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	1.6	-	-	1.6	-	1.6	-	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	2.0	-	-	2.0	-	2.0	-	V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	0.7 × V <sub>CCI</sub>	-	-	0.7 × V <sub>CCI</sub>	-	$0.7 \times V_{CCI}$	-	V
V <sub>IL</sub>	LOW-level	A, B and DIR input [	1]							
	input voltage	V <sub>CCI</sub> = 0.9 V	-	-	$0.3 \times V_{CCI}$	-	$0.3 \times V_{CCI}$	-	0.3 × V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	-	-	0.35 × V <sub>CCI</sub>	-	0.35 × V <sub>CCI</sub>	-	0.35 × V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	-	0.7	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	-	-	0.8	-	0.8	-	0.8	V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	-	-	$0.3 \times V_{CCI}$	-	$0.3 \times V_{CCI}$	-	0.3 × V <sub>CCI</sub>	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH}$ [	2]							
	output voltage	I <sub>O</sub> = -0.1 mA; V <sub>CCO</sub> = 0.9 V to 5.5 V	3] V <sub>CCO</sub> - 0.1	0.9	-	V <sub>CCO</sub> - 0.1	-	V <sub>CCO</sub> - 0.1	-	V
		I <sub>O</sub> = -1.5 mA; V <sub>CCO</sub> = 1.1 V	0.825	-	-	0.825	-	0.825	-	V
		I <sub>O</sub> = -3 mA; V <sub>CCO</sub> = 1.4 V	1.05	-	-	1.05	-	1.05	-	V
		I <sub>O</sub> = -4.5 mA; V <sub>CCO</sub> = 1.65 V	1.2	-	-	1.2	-	1.2	-	V
		I <sub>O</sub> = -8 mA; V <sub>CCO</sub> = 2.3 V	1.7	-	-	1.7	-	1.7	-	V
		I <sub>O</sub> = -10 mA; V <sub>CCO</sub> = 3.0 V	2.2	-	-	2.2	-	2.2	-	V
		I <sub>O</sub> = -12 mA; V <sub>CCO</sub> = 4.5 V	3.7	-	-	3.7	-	3.7	-	V

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# 74AXP1T45

### 1-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions			+25 °C		-40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
				Min	Тур	Мах	Min	Мах	Min	Max	
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IL}$	[2]								
	output voltage	I <sub>O</sub> = 0.1 mA; V <sub>CCO</sub> = 0.9 V to 5.5 V	[3]	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 1.5 mA; V <sub>CCO</sub> = 1.1 V		-	-	0.275	-	0.275	-	0.275	V
		I <sub>O</sub> = 3 mA; V <sub>CCO</sub> = 1.4 V		-	-	0.35	-	0.35	-	0.35	V
		I <sub>O</sub> = 4.5 mA; V <sub>CCO</sub> = 1.65 V		-	-	0.45	-	0.45	-	0.45	V
		I <sub>O</sub> = 8 mA; V <sub>CCO</sub> = 2.3 V		-	-	0.7	-	0.7	-	0.7	V
		I <sub>O</sub> = 10 mA; V <sub>CCO</sub> = 3.0 V		-	-	0.8	-	0.8	-	0.8	V
		I <sub>O</sub> = 8 mA; V <sub>CCO</sub> = 4.5 V		-	-	0.5	-	0.5	-	0.5	V
		I <sub>O</sub> = 12 mA; V <sub>CCO</sub> = 4.5 V		-	-	0.8	-	0.8	-	0.8	V
l <sub>l</sub>	input leakage current	DIR input; $V_I = 0$ V to 5.5 V; $V_{CCI} = 0.9$ V to 5.5 V		-	-	±0.1	-	±0.5	-	±1	μA
I <sub>OZ</sub>	OFF-state	A or B port; $V_0 = 0$ V or $V_{CCO}$ ; $V_{CCO} = 0.9$ V to 5.5 V	[2]	-	-	±0.1	-	±0.5	-	±2	μA
	output current	suspend mode A port; $V_O = 0 V$ or $V_{CCO}$ ; $V_{CC(A)} = 5.5 V$ ; $V_{CC(B)} = 0 V$	[2]	-	-	±0.1	-	±0.5	-	±2	μA
		suspend mode B port; $V_O = 0 V$ or $V_{CCO}$ ; $V_{CC(A)} = 0 V$ ; $V_{CC(B)} = 5.5 V$	[2]	-	-	±0.1	-	±0.5	-	±2	μA
I <sub>OFF</sub>	power-off leakage current	DIR input; $V_I = 0 V$ to 5.5 V; $V_{CC(A)} = 0 V$ ; $V_{CC(B)} = 0.9 V$ to 5.5 V		-	-	0.1	-	0.5	-	2	μA
		A port; V <sub>1</sub> or V <sub>0</sub> = 0 V to 5.5 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.9 V to 5.5 V		-	-	0.1	-	0.5	-	2	μA
		B port; V <sub>1</sub> or V <sub>0</sub> = 0 V to 5.5 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.9 V to 5.5 V		-	-	0.1	-	0.5	-	2	μA
∆I <sub>OFF</sub>	additional power-off	DIR input; V <sub>I</sub> = 0 V or 5.5 V; V <sub>CC(A)</sub> = 0 V to 0.1 V; V <sub>CC(B)</sub> = 0.9 V to 5.5 V		-	-	±0.1	-	±0.5	-	±2	μA
	leakage current	A port; $V_O = 0 V \text{ or } 5.5 V$ ; $V_{CC(A)} = 0 V \text{ to } 0.1 V$ ; $V_{CC(B)} = 0.9 V \text{ to } 5.5 V$ ; $V_I = 0 V \text{ or } 5.5 V$		-	-	±0.1	-	±0.5	-	±2	μA
		B port; $V_O = 0 V \text{ or } 5.5 V$ ; $V_{CC(B)} = 0 V \text{ to } 0.1 V$ ; $V_{CC(A)} = 0.9 V \text{ to } 5.5 V$ ; $V_I = 0 V \text{ or } 5.5 V$		-	-	±0.1	-	±0.5	-	±2	μA

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# 74AXP1T45

#### 1-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions		+25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
I <sub>CC</sub>	supply current	A port; $V_I = 0 V \text{ or } V_{CCI}$ ; $I_O = 0 A$ [1]								
		$V_{CC(A)}$ , $V_{CC(B)} = 0.9$ V to 5.5 V	-	-	2	-	4	-	9	μA
		V <sub>CC(A)</sub> = 5.5 V; V <sub>CC(B)</sub> = 0 V	-	-	2	-	4	-	9	μA
		V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 5.5 V	-	-	±0.1	-	±0.4	-	±1	μA
		B port; $V_I = 0 V$ or $V_{CCI}$ ; $I_O = 0 A$								
		$V_{CC(A)}, V_{CC(B)} = 0.9 V \text{ to } 5.5 V$	-	-	2	-	4	-	9	μA
		V <sub>CC(B)</sub> = 5.5 V; V <sub>CC(A)</sub> = 0 V	-	-	2	-	4	-	9	μA
		V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 5.5 V	-	-	±0.1		±0.4		±1	μA
ΔI <sub>CC</sub>	additional supply current	per input; other pins at $V_{CCI}$ or ground (0 V); $I_O = 0 A$ ; [4) $V_{CC(A)}$ , $V_{CC(B)} = 4.5 V$ to 5.5 V; $V_I = V_{CCI} - 0.6 V$	-	2	100	-	150	-	200	μA

[1]  $V_{CCI}$  is the supply voltage associated with the control input or input port.

[2]  $V_{CCO}$  is the supply voltage associated with the output port. [3] Typical values for  $V_{OL}$  and  $V_{OH}$  are measured at  $V_{CCO}$  is 0.9 V. [4] Typical values for  $\Delta I_{CC}$  are measured at  $V_{CC(A)}$ ,  $V_{CC(B)} = 5$  V.

### Table 8. Typical total supply current I<sub>CC(A)</sub> at T<sub>amb</sub> = 25 °C

Voltages are referenced to GND (ground = 0 V).

V <sub>CC(A)</sub>	V <sub>CC(B)</sub>										
	0 V	0.9 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V			
0 V	0.00	0.01	0.01	0.01	0.01	0.01	0.01	0.01	μA		
0.9 V	0.01	0.08	0.08	0.08	0.08	0.08	0.08	0.08	μA		
1.2 V	0.01	0.10	0.10	0.10	0.10	0.10	0.10	0.10	μA		
1.5 V	0.01	0.13	0.13	0.13	0.13	0.13	0.13	0.13	μA		
1.8 V	0.01	0.16	0.16	0.16	0.16	0.16	0.16	0.16	μA		
2.5 V	0.01	0.22	0.22	0.22	0.22	0.22	0.22	0.22	μA		
3.3 V	0.01	0.29	0.29	0.29	0.29	0.29	0.29	0.29	μA		
5.0 V	0.01	0.44	0.44	0.44	0.44	0.44	0.44	0.44	μA		

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1-bit dual supply translating transceiver; 3-state

### Table 9. Typical total supply current I<sub>CC(B)</sub> at T<sub>amb</sub> = 25 °C

Voltages are referenced to GND (ground = 0 V).

V <sub>CC(A)</sub>				Vo	:C(B)				Unit
	0 V	0.9 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
0 V	0.00	0.01	0.01	0.01	0.01	0.01	0.01	0.01	μA
0.9 V	0.01	0.08	0.10	0.13	0.16	0.22	0.29	0.44	μA
1.2 V	0.01	0.08	0.10	0.13	0.16	0.22	0.29	0.44	μA
1.5 V	0.01	0.08	0.10	0.13	0.16	0.22	0.29	0.44	μA
1.8 V	0.01	0.08	0.10	0.13	0.16	0.22	0.29	0.44	μA
2.5 V	0.01	0.08	0.10	0.13	0.16	0.22	0.29	0.44	μA
3.3 V	0.01	0.08	0.10	0.13	0.16	0.22	0.29	0.44	μA
5.0 V	0.01	0.08	0.10	0.13	0.16	0.22	0.29	0.44	μA

# **11. Dynamic characteristics**

Symbol	Parameter	Conditions	Conditions		V <sub>CC(B)</sub>								
					1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	]		
t <sub>pd</sub>	propagation delay	A to B	[1]	40	22	18.5	16.5	15	15	15	ns		
		B to A	[1]	40	33	32	31	31	31	32	ns		
t <sub>dis</sub>	disable time	DIR to A	[1]	34	34	34	34	34	34	34	ns		
		DIR to B	[1]	42	30	26	26	24	25	23	ns		
t <sub>en</sub>	enable time	DIR to A	[1]	82	63	58	57	55	56	55	ns		
		DIR to B	[1]	74	56	53	51	49	49	49	ns		

# Table 10. Typical dynamic characteristics at $V_{CC(A)}$ = 0.9 V and $T_{amb}$ = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7; for waveforms see Fig. 5 and Fig. 6.

 $[1] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}; \ t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}; \ t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}.$ 

#### Table 11. Typical dynamic characteristics at $V_{CC(B)}$ = 0.9 V and $T_{amb}$ = 25 °C

#### Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7; for waveforms see Fig. 5 and Fig. 6.

Symbol	Parameter	Conditions					V <sub>CC(A)</sub>				Unit
				0.9 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t <sub>pd</sub>	propagation delay	A to B	[1]	40	33	32	31	31	31	32	ns
		B to A	[1]	40	22	18.5	16.5	15	15	15	ns
t <sub>dis</sub>	disable time	DIR to A	[1]	34	16	11	10	7.0	7.7	5.3	ns
		DIR to B	[1]	42	31	28	28	27	27	27	ns
t <sub>en</sub>	enable time	DIR to A	[1]	82	53	47	45	42	42	42	ns
		DIR to B	[1]	74	49	43	41	38	39	37	ns

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

#### Table 12. Typical dynamic characteristics at T<sub>amb</sub> = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

Symbol	Parameter	Conditions			V <sub>CC(</sub>	) and <b>\</b>	/ <sub>CC(B)</sub>			Unit
			0.9 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
C <sub>PD</sub>	power dissipation capacitance	A port: (direction A to B); [1] B port: (direction B to A) [2]	1.5	1.6	1.7	1.7	1.9	2.1	2.7	pF
		A port: (direction B to A); [1] B port: (direction A to B) [2]	10	10.4	10.6	10.7	10.9	11.3	12.1	pF
CI	input capacitance	$V_{I} = 0 V \text{ or } V_{CCI}; V_{CCI} = 0 V \text{ to } 5.5 V$	1.9	1.9	1.9	1.9	1.9	1.9	1.9	pF
C <sub>I/O</sub>	input/output capacitance	$V_{O} = 0 V; V_{CCO} = 0 V$	4.5	4.5	4.5	4.5	4.5	4.5	4.5	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_o$  = output frequency in MHz;

 $C_L$  = load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$ 

[2]  $f_i = 1$  MHz;  $V_I = GND$  to  $V_{CC}$ ;  $t_r = t_f = 1$  ns;  $C_L = 0$  pF;  $R_L = \infty \Omega$ .

#### Table 13. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7; for waveforms see Fig. 5 and Fig. 6.

Symbol	Parameter	Conditions						Vc	С(В)						Unit
			1.2 V :	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	: 0.15 V	2.5 V :	± 0.2 V	3.3 V	± 0.3 V	5.0 V :	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
t <sub>pd</sub>	propagation	A to B [1]													
	delay	V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	4.0	38	3.6	25	3.4	21	3.1	16	2.9	14.5	2.7	14.5	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	3.5	33	3.0	21	2.8	16.5	2.6	12.5	2.4	10.5	2.2	9.8	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	3.1	32	2.7	19	2.4	15	2.2	11	2.1	9.0	1.9	8.2	ns
		$V_{CC(A)} = 2.5 V \pm 0.2 V$	2.8	31	2.4	17.5	2.1	13.5	1.9	9.1	1.7	7.5	1.6	6.6	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	2.7	31	2.3	17	2.0	13	1.8	8.5	1.6	6.9	1.4	5.8	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	2.7	31	2.2	16.5	1.9	12.5	1.6	8.1	1.4	6.4	1.2	5.0	ns
		B to A													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	4.0	38	3.5	33	3.1	32	2.8	31	2.7	31	2.7	31	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	3.6	25	3.0	21	2.7	19	2.4	17.5	2.3	17	2.2	16.5	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	3.4	21	2.8	16.5	2.4	15	2.1	13.5	2.0	13	1.9	12.5	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	3.1	16	2.6	12.5	2.2	11	1.9	9.1	1.8	8.5	1.6	8.1	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	2.9	14.5	2.4	10.5	2.1	9.0	1.7	7.5	1.6	6.9	1.4	6.4	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	2.7	14.5	2.2	9.8	1.9	8.2	1.6	6.6	1.4	5.8	1.2	5.0	ns

### 1-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions						Vc	С(В)						Unit
			1.2 V :	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	: 0.15 V	2.5 V :	± 0.2 V	3.3 V	± 0.3 V	5.0 V	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
t <sub>en</sub>	enable time	DIR to A [1]													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	9.6	67.3	9.6	67.3	9.6	67.3	9.6	67.3	9.6	67.3	9.6	67.3	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	7.4	37.5	7.4	37.5	7.4	37.5	7.4	37.5	7.4	37.5	7.4	37.5	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	6.7	29	6.7	29	6.7	29	6.7	29	6.7	29	6.7	29	ns
		$V_{CC(A)} = 2.5 V \pm 0.2 V$	4.9	19	4.9	19	4.9	19	4.9	19	4.9	19	4.9	19	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	5.3	17.3	5.3	17.3	5.3	17.3	5.3	17.3	5.3	17.3	5.3	17.3	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	3.7	12	3.7	12	3.7	12	3.7	12	3.7	12	3.7	12	ns
		DIR to B													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	8.9	58.3	8.5	49.3	8.3	47	8.0	45.8	7.8	45	7.6	44.7	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	7.4	45.2	6.9	32.5	6.7	29.8	6.5	27.2	6.3	26.6	6.1	26	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	7.1	42	6.7	28.9	6.4	26.2	6.2	23.9	6.1	23	5.9	22.5	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	5.7	37	5.3	25	5.0	22.5	4.8	20.1	4.6	19	4.5	18.4	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	6.2	37.2	5.8	23.8	5.5	21.2	5.3	18.6	5.1	17.7	4.9	17.1	ns
		$V_{CC(A)} = 5.0 \text{ V} \pm 0.5 \text{ V}$	5.1	33.7	4.6	21	4.3	18.2	4.0	15.7	3.8	14.6	3.6	13.9	ns

### 1-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions						Vc	С(В)						Unit
			1.2 V	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	± 0.15 V	2.5 V :	± 0.2 V	3.3 V	± 0.3 V	5.0 V	± 0.5 V	
			Min	Max	Min	Мах	Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>dis</sub>	disable time	DIR to A [1]													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	4.9	31	4.9	31	4.9	31	4.9	31	4.9	31	4.9	31	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	3.9	17.8	3.9	17.8	3.9	17.8	3.9	17.8	3.9	17.8	3.9	17.8	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	4.0	15.9	4.0	15.9	4.0	15.9	4.0	15.9	4.0	15.9	4.0	15.9	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	2.9	12.9	2.9	12.9	2.9	12.9	2.9	12.9	2.9	12.9	2.9	12.9	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	3.5	12.3	3.5	12.3	3.5	12.3	3.5	12.3	3.5	12.3	3.5	12.3	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	2.4	9.6	2.4	9.6	2.4	9.6	2.4	9.6	2.4	9.6	2.4	9.6	ns
		DIR to B													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	5.6	36.8	4.8	27.9	5.1	26.7	4.4	22.8	5.1	23.5	4.1	20.7	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	5.1	32.3	4.4	23.1	4.6	21.8	3.8	17.6	4.6	18.5	3.6	15.8	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	4.7	30.9	4.0	21.5	4.3	20	3.4	16	4.2	15.5	3.3	13.2	ns
		$V_{CC(A)} = 2.5 V \pm 0.2 V$	4.3	29	3.6	20	3.9	17.7	3.0	14	3.9	14.3	2.9	10.7	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	4.2	28.9	3.5	19	3.7	16.7	2.9	12.6	3.7	13	2.7	10.3	ns
		$V_{CC(A)} = 5.0 \text{ V} \pm 0.5 \text{ V}$	4.1	27.8	3.3	18.9	3.6	16.5	2.7	12.4	3.5	12.4	2.5	9.4	ns
t <sub>t</sub>	transition	A, B output													
	time	V <sub>CC(A)</sub> = 1.1 V to 5.5 V	1.0	-	1.0	-	1.0	-	1.0	-	1.0	-	1.0	-	ns

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

#### Table 14. Dynamic characteristics for temperature range -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7; for waveforms see Fig. 5 and Fig. 6.

Symbol	Parameter	Conditions						Vc	С(В)						Unit
			1.2 V :	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	: 0.15 V	2.5 V :	± 0.2 V	3.3 V	± 0.3 V	5.0 V :	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
t <sub>pd</sub>	propagation	A to B [1]													
	delay	V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	4.0	38	3.6	26	3.4	22	3.1	17	2.9	15	2.7	15	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	3.5	33	3.0	22	2.8	17.5	2.6	13.5	2.4	11.5	2.2	10.5	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	3.1	32	2.7	20	2.4	16	2.2	12	2.1	9.7	1.9	9.4	ns
		$V_{CC(A)} = 2.5 V \pm 0.2 V$	2.8	31	2.4	18.5	2.1	14.5	1.9	9.8	1.7	8.1	1.6	7.1	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	2.7	31	2.3	18	2.0	14	1.8	9.2	1.6	7.5	1.4	6.3	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	2.7	31	2.2	17.5	1.9	13.5	1.6	8.8	1.4	6.9	1.2	5.5	ns
		B to A													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	4.0	38	3.5	33	3.1	32	2.8	31	2.7	31	2.7	31	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	3.6	26	3.0	22	2.7	20	2.4	18.5	2.3	18	2.2	17.5	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	3.4	22	2.8	17.5	2.4	16	2.1	14.5	2.0	14	1.9	13.5	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	3.1	17	2.6	13.5	2.2	12	1.9	9.8	1.8	9.2	1.6	8.8	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	2.9	15	2.4	11.5	2.1	9.7	1.7	8.1	1.6	7.5	1.4	6.9	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	2.7	15	2.2	10.5	1.9	9.4	1.6	7.1	1.4	6.3	1.2	5.5	ns

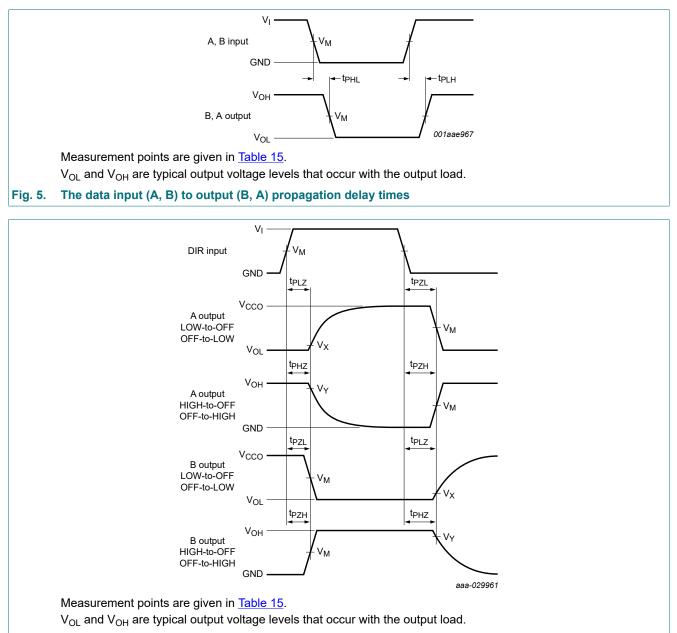
### 1-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions						Vc	C(B)						Unit
			1.2 V	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	± 0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>en</sub>	enable time	DIR to A [1]													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	9.6	67.6	9.6	67.6	9.6	67.6	9.6	67.6	9.6	67.6	9.6	67.6	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	7.4	38	7.4	38	7.4	38	7.4	38	7.4	38	7.4	38	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	6.7	30.2	6.7	30.2	6.7	30.2	6.7	30.2	6.7	30.2	6.7	30.2	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	4.9	19.9	4.9	19.9	4.9	19.9	4.9	19.9	4.9	19.9	4.9	19.9	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	5.3	17.9	5.3	17.9	5.3	17.9	5.3	17.9	5.3	17.9	5.3	17.9	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	3.7	12.2	3.7	12.2	3.7	12.2	3.7	12.2	3.7	12.2	3.7	12.2	ns
		DIR to B													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	8.9	58.6	8.5	49.8	8.3	47.3	8.0	46	7.8	45.5	7.6	44.9	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	7.4	45.9	6.9	33.3	6.7	30	6.5	27.8	6.3	26.8	6.1	26.3	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	7.1	42.5	6.7	30	6.4	27	6.2	24.5	6.1	24	5.9	23	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	5.7	37.6	5.3	25.2	5.0	22.7	4.8	20.3	4.6	19.2	4.5	18.5	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	6.2	37.5	5.8	24.8	5.5	21.5	5.3	18.9	5.1	18	4.9	17.3	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	5.1	34.1	4.6	21.5	4.3	18.5	4.0	15.9	3.8	14.8	3.6	14	ns

### 1-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions						Vc	С(В)						Unit
			1.2 V	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	± 0.15 V	2.5 V :	± 0.2 V	3.3 V	± 0.3 V	5.0 V	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Мах	Min	Max	1
t <sub>dis</sub>	disable time	DIR to A [1]													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	4.9	31.2	4.9	31.2	4.9	31.2	4.9	31.2	4.9	31.2	4.9	31.2	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	3.9	18	3.9	18	3.9	18	3.9	18	3.9	18	3.9	18	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	4.0	16	4.0	16	4.0	16	4.0	16	4.0	16	4.0	16	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	2.9	13	2.9	13	2.9	13	2.9	13	2.9	13	2.9	13	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	3.5	12.4	3.5	12.4	3.5	12.4	3.5	12.4	3.5	12.4	3.5	12.4	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	2.4	9.7	2.4	9.7	2.4	9.7	2.4	9.7	2.4	9.7	2.4	9.7	ns
		DIR to B													
		V <sub>CC(A)</sub> = 1.2 V ± 0.1 V	5.6	37	4.8	28.3	5.1	27.1	4.4	23.2	5.1	23.8	4.1	21	ns
		V <sub>CC(A)</sub> = 1.5 V ± 0.1 V	5.1	32.6	4.4	23.6	4.6	22	3.8	18	4.6	18.7	3.6	16	ns
		V <sub>CC(A)</sub> = 1.8 V ± 0.15 V	4.7	31.1	4.0	22	4.3	20.1	3.4	16.1	4.2	15.6	3.3	13.4	ns
		V <sub>CC(A)</sub> = 2.5 V ± 0.2 V	4.3	29.8	3.6	20.2	3.9	17.9	3.0	14.1	3.9	14.4	2.9	10.9	ns
		V <sub>CC(A)</sub> = 3.3 V ± 0.3 V	4.2	29.1	3.5	19.1	3.7	16.9	2.9	12.9	3.7	13.1	2.7	10.4	ns
		V <sub>CC(A)</sub> = 5.0 V ± 0.5 V	4.1	28	3.3	19	3.6	16.7	2.7	12.5	3.5	12.5	2.5	9.5	ns
t <sub>t</sub>	transition	A, B output													
	time	V <sub>CC(A)</sub> = 1.1 V to 5.5 V	1.0	-	1.0	-	1.0	-	1.0	-	1.0	-	1.0	-	ns

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .



### 11.1. Waveforms and test circuit

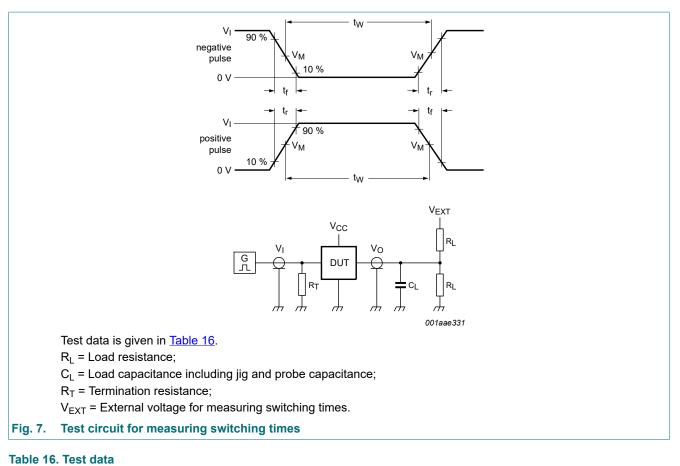
Fig. 6. Enable and disable times

Table 15. Measuren Supply voltage	nent points Input[1]	Output[2]		
$V_{CC(A)}, V_{CC(B)}$	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
0.9 V to 1.6 V	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	V <sub>OL</sub> + 0.1 V	V <sub>OH</sub> - 0.1 V
1.65 V to 2.7 V	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V
3.0 V to 5.5 V	0.5 × V <sub>CCI</sub>	$0.5 \times V_{CCO}$	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V

[1] V<sub>CCI</sub> is the supply voltage associated with the control input or input port.

[2]  $V_{CCO}$  is the supply voltage associated with the output port.

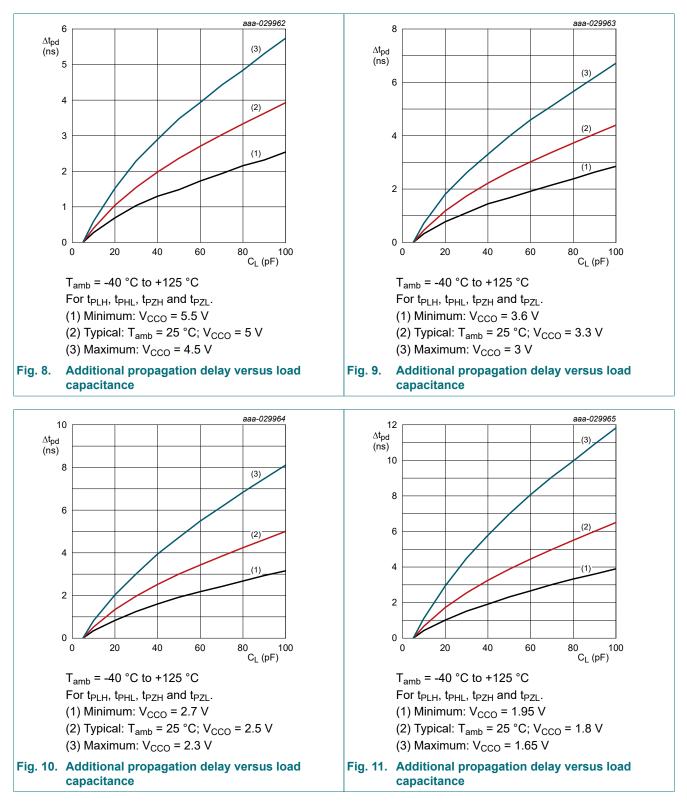
### 1-bit dual supply translating transceiver; 3-state



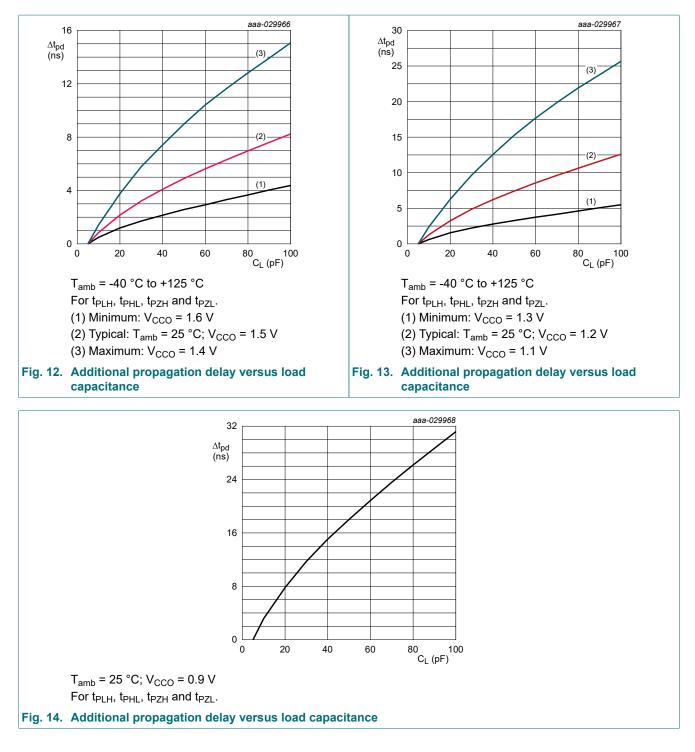
#### Supply voltage Input Load VEXT V<sub>CC(A)</sub>, V<sub>CC(B)</sub> $C_L$ $R_L$ t<sub>r</sub>, t<sub>f</sub> V<sub>I</sub> [1] t<sub>PLH</sub>, t<sub>PHL</sub> t<sub>PZL</sub>, t<sub>PLZ</sub> [2] t<sub>PZH</sub>, t<sub>PHZ</sub> 0.9 V to 5.5 V GND $2 \times V_{CCO}$ 5 pF 10 kΩ ≤3.0 ns GND V<sub>CCI</sub>

[1] V<sub>CCI</sub> is the supply voltage associated with the control input or input port.

[2] V<sub>CCO</sub> is the supply voltage associated with the output port.



### 11.2. Additional propagation delay versus load capacitance graphs



# **12.** Application information

### 12.1. Unidirectional logic level-shifting application

The circuit given in <u>Fig. 15</u> is an example of the 74AXP1T45 being used in an unidirectional logic level-shifting application.

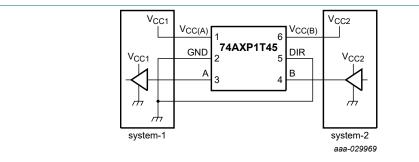


Fig. 15. Unidirectional logic level-shifting application

Pin	Name	Function	Description
1	V <sub>CC(A)</sub>	V <sub>CC1</sub>	supply voltage of system-1 (0.9 V to 5.5 V)
2	GND	GND	device GND
3	А	OUT	output level depends on $V_{CC1}$ voltage
4	В	IN	input threshold value depends on $V_{CC2}$ voltage
5	DIR	DIR	the GND (LOW level) determines B port to A port direction
6	V <sub>CC(B)</sub>	V <sub>CC2</sub>	supply voltage of system-2 (0.9 V to 5.5 V)

<b>Table 17. Description</b>	unidirectional logic level-shiftin	g application

### **12.2.** Bidirectional logic level-shifting application

Fig. 16 shows the 74AXP1T45 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.

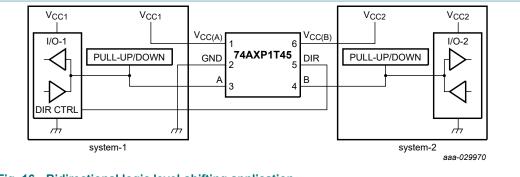


Fig. 16. Bidirectional logic level-shifting application

<u>Table 18</u> gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

#### Table 18. Description bidirectional logic level-shifting application

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Н	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold.
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold.
4	L	input	output	system-2 data to system-1

### 12.3. Enable times

Calculate the enable times for the 74AXP1T45 using the following formulas:

- Direction A to B:
  - $t_{PZL}$  (DIR to B) =  $t_{PHL}$  (A to B) +  $t_{PHZ}$  (DIR to A)
  - $t_{PZH}$  (DIR to B) =  $t_{PLH}$  (A to B) +  $t_{PLZ}$  (DIR to A)
- Direction B to A:
  - $t_{PZL}$  (DIR to A) =  $t_{PHL}$  (B to A) +  $t_{PHZ}$  (DIR to B)
  - $t_{PZH}$  (DIR to A) =  $t_{PLH}$  (B to A) +  $t_{PLZ}$  (DIR to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74AXP1T45 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

# 13. Package outline

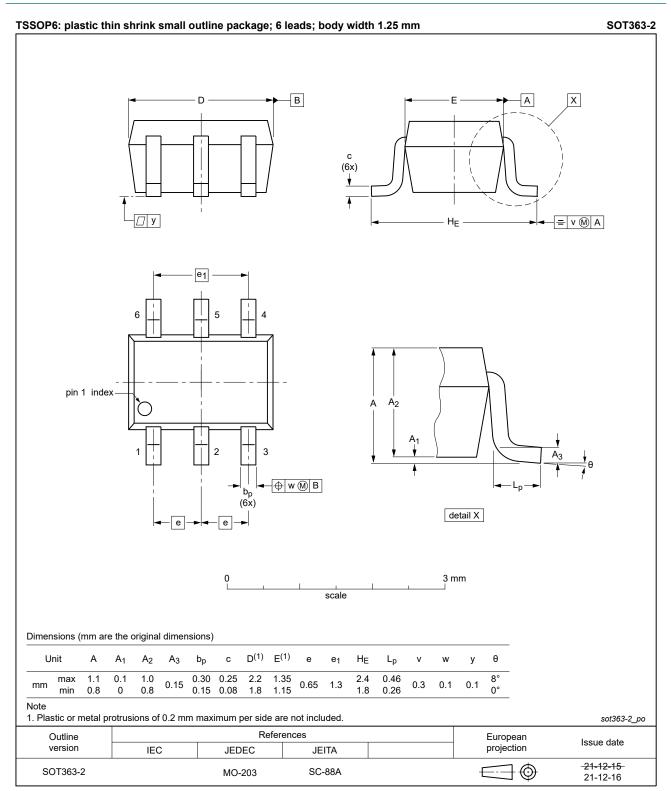
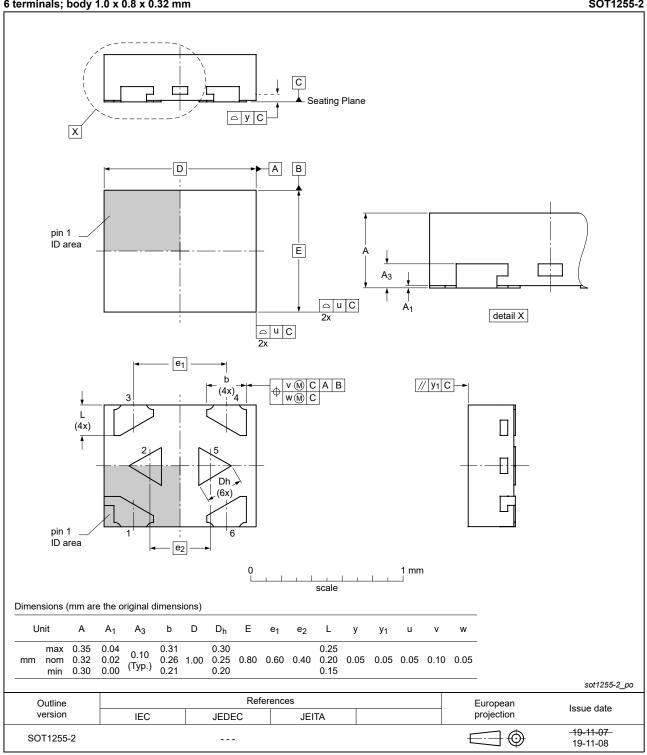


Fig. 17. Package outline SOT363-2 (TSSOP6)

# X2SON6: plastic thermal enhanced extremely thin small outline package; no leads; 6 terminals; body 1.0 x 0.8 x 0.32 mm







# 14. Abbreviations

Table 19. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			

# 15. Revision history

### Table 20. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AXP1T45 v.2	20220203	Product data sheet	-	74AXP1T45 v.1	
Modifications	Package SOT363 (SC-88) changed to SOT363-2 (TSSOP6).				
74AXP1T45 v.1	20200625	Product data sheet	-	-	

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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